

Axial lead diode

High efficiency super fast silicon rectifier diode

HE6SF200

Forward Current: 6 A

Reverse Voltage: 200 to 200 V

Features

- Max. solder temperature: 260°C
- Plastic material has UL classification 94V-0

Mechanical Data

- Plastic case 8 x 7,5 [mm]
- Weight approx.: 1,5 g
- Terminals: plated terminals solderable per MIL-STD-750
- Mounting position: any
- Standard packaging: 500 pieces per ammo

1) Valid, if leads are kept at ambient temperature at a distance of 10 mm from case

2) $I_F = 5 \text{ A}$, $T_j = 25^\circ\text{C}$

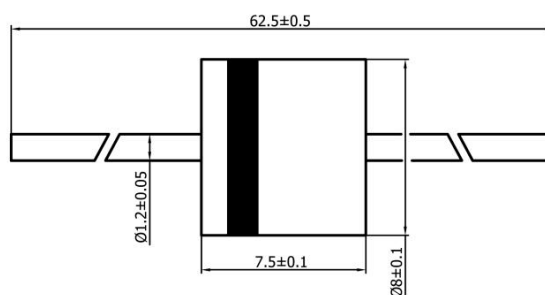
3) $T_A = 25^\circ\text{C}$

Type	Repetitive peak reverse voltage	Surge peak reverse voltage	Max. reverse recovery time	Max. forward voltage
	V_{RRM} V	V_{RSM} V	$I_F = 0,5 \text{ A}$ $I_R = 1 \text{ A}$ $I_{RR} = 0,25 \text{ A}$ t_{rr} ns	$V_F^{2)}$
HE6SF200	200	200	200	0,95

Absolute Maximum Ratings Tc = 25 °C, unless otherwise specified			
Symbol	Conditions	Values	Units
I_{FAV}	Max. averaged fwd. current, R-load, $T_A = 45^\circ\text{C}$ ¹⁾	6	A
I_{FRM}	Repetitive peak forward current $f > 15 \text{ Hz}$ ¹⁾	60	A
I_{FSM}	Peak forward surge current 50 Hz half sinus-wave ³⁾	300	A
i^2t	Rating for fusing, $t < 10 \text{ ms}$ ³⁾	450	A ² s
R_{thA}	Max. thermal resistance junction to ambient ¹⁾	20	K/W
R_{thT}	Max. thermal resistance junction to terminals ¹⁾	-	K/W
T_j	Operating junction temperature	-50...+175	°C
T_s	Storage temperature	-50...+175	°C

Characteristics Tc = 25 °C, unless otherwise specified			
Symbol	Conditions	Values	Units
I_R	Maximum leakage current, $T_j = 25^\circ\text{C}$; $V_R = V_{RRM}$	<5	µA
	$T_j = 25^\circ\text{C}$; $V_R = V_{RRM}$		
C_j	Typical junction capacitance (at MHz and applied reverse voltage of V)	-	pF
Q_{rr}	Reverse recovery charge ($U_R = V$; $I_F = A$; $dI_F/dt = A/ms$)	-	µC
E_{RSM}	Non repetitive peak reverse avalanche energy ($I_R = mA$; $T_j = 25^\circ\text{C}$; inductive load switched off)	-	mJ

Dimensions in mm



case: 8 x 7,5 [mm]

